

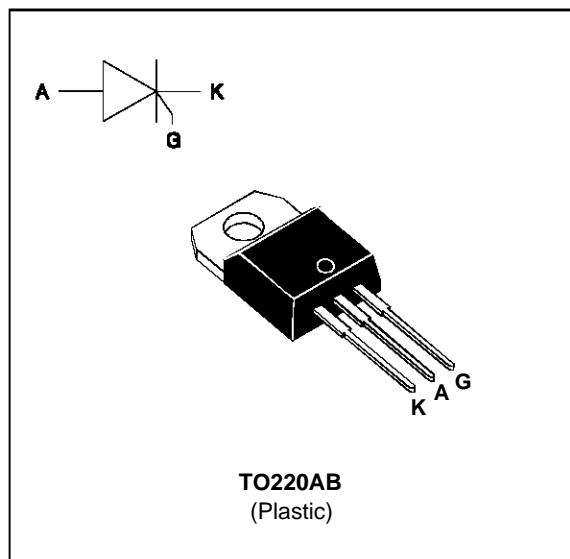
**FEATURES**

- HIGH SURGE CAPABILITY
- HIGH ON-STATE CURRENT
- HIGH STABILITY AND RELIABILITY

**DESCRIPTION**

The TYN 056 ---> TYN 1006 Family Silicon Controlled Rectifiers are high performance glass passivated chips technology.

This general purpose Family Silicon Controlled Rectifiers is designed for power supply up to 400Hz on resistive or inductive load.



**ABSOLUTE RATINGS** (limiting values)

Symbol	Parameter	Value	Unit
$I_{T(RMS)}$	RMS on-state current (180° conduction angle)	$T_c = 110\text{ °C}$ 6	A
$I_{T(AV)}$	Average on-state current (180° conduction angle, single phase circuit)	$T_c = 110\text{ °C}$ 3.8	A
$I_{TSM}$	Non repetitive surge peak on-state current ( $T_j$ initial = 25°C )	$t_p = 8.3\text{ ms}$ 73	A
		$t_p = 10\text{ ms}$ 70	
$I^2t$	$I^2t$ value	$t_p = 10\text{ ms}$ 24.5	A <sup>2</sup> s
$di/dt$	Critical rate of rise of on-state current Gate supply : $I_G = 100\text{ mA}$ $di_G/dt = 1\text{ A}/\mu\text{s}$	50	A/ $\mu\text{s}$
$T_{stg}$ $T_j$	Storage and operating junction temperature range	- 40 to + 150 - 40 to + 125	°C °C
$T_l$	Maximum lead temperature for soldering during 10 s at 4.5 mm from case	260	°C

Symbol	Parameter	TYN							Unit
		056	106	206	406	606	806	1006	
$V_{DRM}$ $V_{RRM}$	Repetitive peak off-state voltage $T_j = 125\text{ °C}$	50	100	200	400	600	800	1000	V

**THERMAL RESISTANCES**

Symbol	Parameter	Value	Unit
Rth (j-a)	Junction to ambient	60	°C/W
Rth (j-c) DC	Junction to case for DC	2.5	°C/W

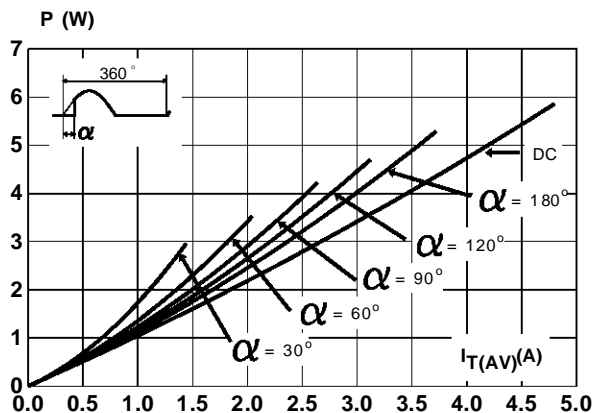
**GATE CHARACTERISTICS (maximum values)**

$P_G (AV) = 1W$   $P_{GM} = 10W$  ( $t_p = 20 \mu s$ )  $I_{FGM} = 4A$  ( $t_p = 20 \mu s$ )  $V_{RGM} = 5V$ .

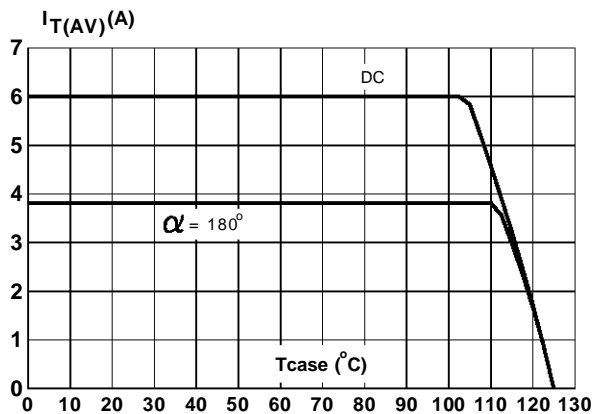
**ELECTRICAL CHARACTERISTICS**

Symbol	Test Conditions			Value	Unit
$I_{GT}$	$V_D=12V$ (DC) $R_L=33\Omega$	$T_j=25^\circ C$	MAX	15	mA
$V_{GT}$	$V_D=12V$ (DC) $R_L=33\Omega$	$T_j=25^\circ C$	MAX	1.5	V
$V_{GD}$	$V_D=V_{DRM}$ $R_L=3.3k\Omega$	$T_j=110^\circ C$	MIN	0.2	V
tgt	$V_D=V_{DRM}$ $I_G = 40mA$ $di_G/dt = 0.5A/\mu s$	$T_j=25^\circ C$	TYP	2	$\mu s$
$I_L$	$I_G= 1.2 I_{GT}$	$T_j=25^\circ C$	TYP	50	mA
$I_H$	$I_T= 100mA$ gate open	$T_j=25^\circ C$	MAX	30	mA
$V_{TM}$	$I_{TM}= 12A$ $t_p= 380\mu s$	$T_j=25^\circ C$	MAX	1.6	V
$I_{DRM}$ $I_{RRM}$	$V_{DRM}$ Rated $V_{RRM}$ Rated	$T_j=25^\circ C$	MAX	0.01	mA
		$T_j=110^\circ C$		2	
dV/dt	Linear slope up to $V_D=67\%V_{DRM}$ gate open	$T_j=110^\circ C$	MIN	200	$V/\mu s$
tq	$V_D=67\%V_{DRM}$ $I_{TM}= 12A$ $V_R= 25V$ $di_{TM}/dt=30 A/\mu s$ $dV_D/dt= 50V/\mu s$	$T_j=110^\circ C$	TYP	70	$\mu s$

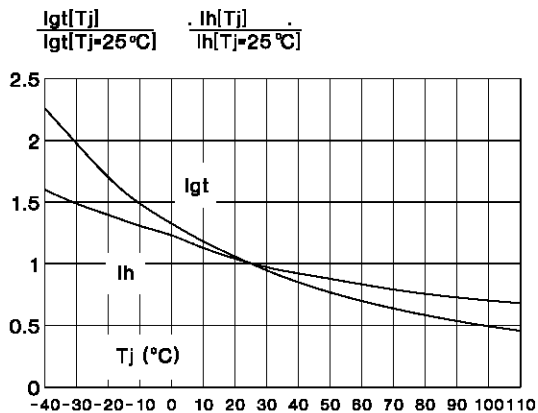
**Fig.1** : Maximum average power dissipation versus average on-state current.



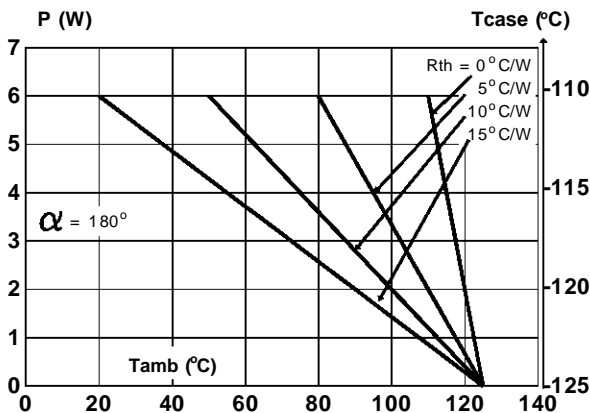
**Fig.3** : Average on-state current versus case temperature.



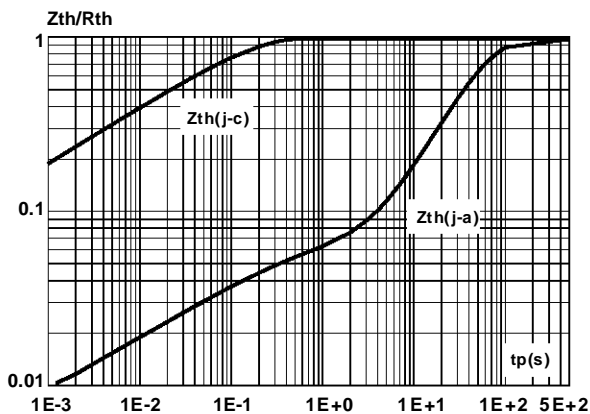
**Fig.5** : Relative variation of gate trigger current versus junction temperature.



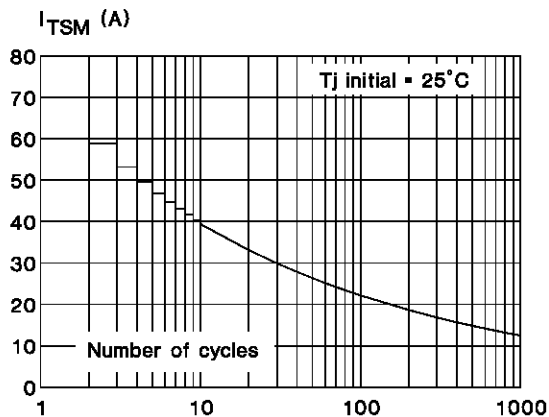
**Fig.2** : Correlation between maximum average power dissipation and maximum allowable temperatures ( $T_{amb}$  and  $T_{case}$ ) for different thermal resistances heatsink + contact.



**Fig.4** : Relative variation of thermal impedance versus pulse duration.

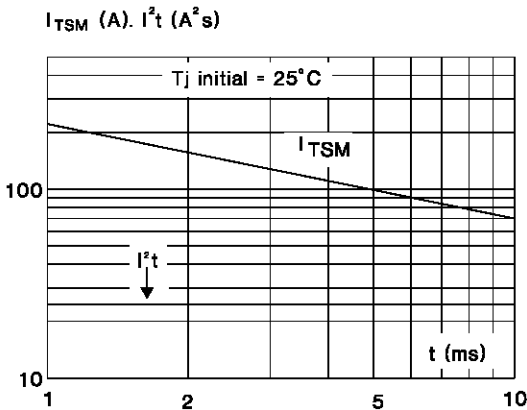


**Fig.6** : Non repetitive surge peak on-state current versus number of cycles.

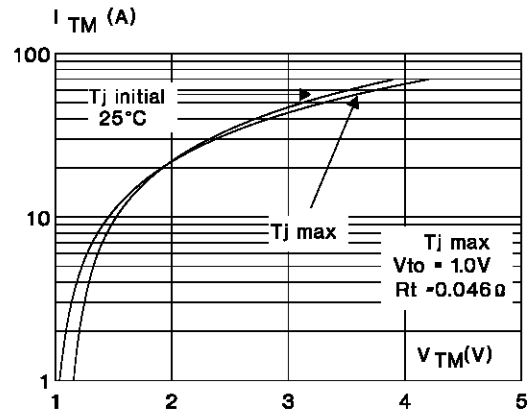


## TYN 056 ---> TYN 1006

**Fig.7** : Non repetitive surge peak on-state current for a sinusoidal pulse with width :  $t \leq 10$  ms, and corresponding value of  $I^2t$ .

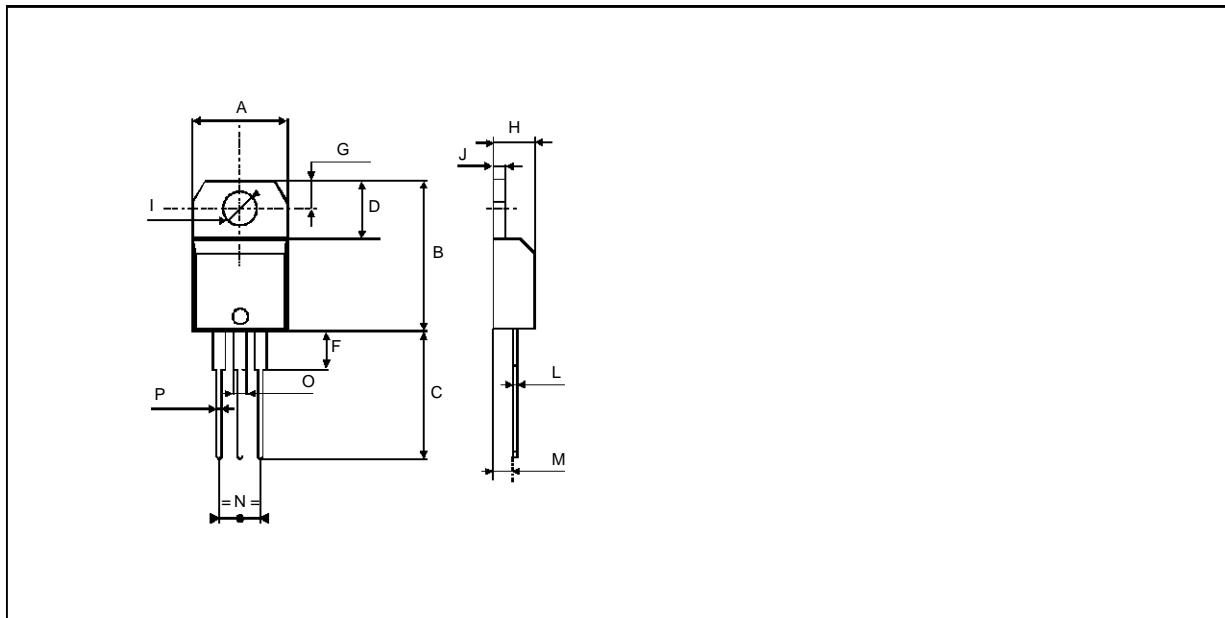


**Fig.8** : On-state characteristics (maximum values).



## PACKAGE MECHANICAL DATA

TO220AB Plastic



Cooling method : C  
Marking : type number  
Weight : 2.3 g

Recommended torque value : 0.8 m.N.  
Maximum torque value : 1 m.N.

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